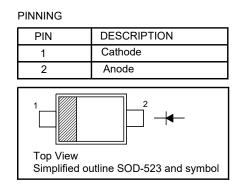
1N914WT

Silicon Epitaxial Planar Switching Diode

Features

- Fast switching speed
- Ultra-small surface mount package
- For general purpose switching applications



Absolute Maximum Ratings (T_a = 25°C)

Parameter	Symbol	Value	Unit
Repetitive Reverse Voltage	V _{RRM}	100	V
Average Rectified Forward Current	I _{F(AV)}	200	mA
Non-repetitive Peak Forward Surge Current Pulse Width = 1 s Pulse Width = 1 μs	I _{FSM}	1 2	А
Power Dissipation	P _D	150	mW
Junction Temperature	Tj	150	C°
Storage Temperature Range	T _{stg}	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient ¹⁾	$R_{ extsf{ heta}JA}$	833	°C/W

¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Electrical Characteristics ($T_a = 25^{\circ}C$)

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I _R = 5 μA at I _R = 100 μA	V _{(BR)R}	75 100	-	V
Forward Voltage at I _F = 10 mA	V _F	-	1	V
Reverse Current at $V_R = 20 V$ at $V_R = 75 V$	I _R	-	25 5	nA μA
Diode Capacitance at V _R = 0 V, f = 1 MHz	C _{tot}	-	4	pF
Reverse Recovery Time at $I_F = 10 \text{ mA}$, $I_{rr} = 0.1 \times I_R$, $V_R = 6 \text{ V}$, $R_L = 100 \Omega$	t _{rr}	-	4	ns



Electrical Characteristics Curves

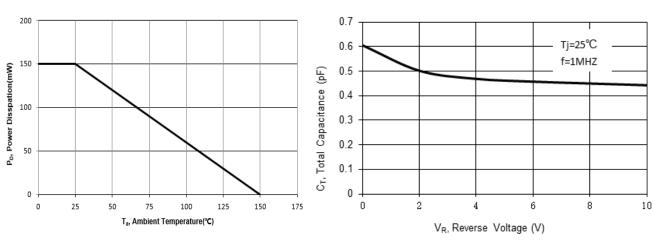


Fig 1. Power Derating Curve

Fig 2. Total Capacitance vs. Reverse Voltage

Fig 3. Reverse Current vs. Reverse Voltage

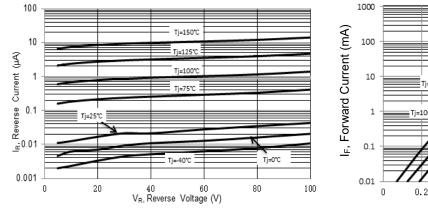
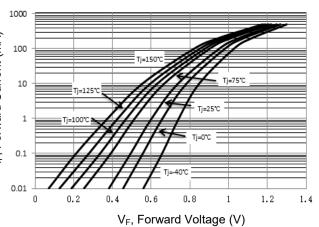


Fig 4. Forward Characteristics

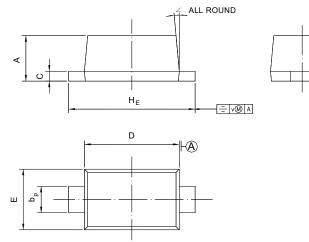




PACKAGE OUTLINE

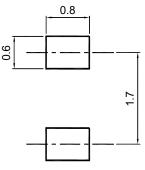
Plastic surface mounted package; 2 leads

SOD-523



UNIT	А	bp	С	D	E	H _E	V	2
mm	0.70 0.60	0.4 0.3	0.135 0.100	1.25 1.15	0.85 0.75	1.7 1.5	0.1	5°

Recommended Soldering Footprint



Packing information

Dealara	Tape Width	Pitch		Reel Size		Day David Daviding Output
Package	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity
SOD-523	8	4 ± 0.1	0.157 ± 0.004	178	7	4,000

Marking information

" A " = Part No. " III " = Cathode line Font type: Arial

— A —

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